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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chi-Feng Wang	12/24/2006
Chun-Hsing Hsieh	12/24/2006
Chia-Wei Yu	12/24/2006

RECEIVING PARTY DATA

Name:	Realtek Semiconductor Corp.	
Street Address:	2 Innovation Rd. II, Science Park	
City:	HsinChu	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11616844

CORRESPONDENCE DATA

Fax Number: (703)997-4517

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 3027291562

Email: Patent.admin.uspto.cr@naipo.com

Correspondent Name: WINSTON HSU
Address Line 1: P.O.BOX 506

Address Line 4: Merrifield, VIRGINIA 22116

ATTORNEY DOCKET NUMBER:	REAP0275USA
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NAME OF SUBMITTER: WINSTON HSU

Total Attachments: 2

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PATENT REEL: 018683 FRAME: 0882

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

1	Name:	Chi-Feng Wang	Nationality: R.O.C.	
A	Address:	2F, No. 3, Lane 19, Anping Rd., Chunghe City,	Taipei Hsien, Taiwan, R.O.C.	
	Name:	Chun Uging Ugiah	Nationality: ROC	
		Chun-Hsing Hsieh		
F	Address:	6F, No. 10, Lane 180, Shipin Rd., Hsin-Chu City, Taiwan, R.O.C.		
1	Name:	Chia-Wei Yu	Nationality: R.O.C.	
A	Address:	5F, No. 131, Sec. 2, Dingchou Rd., Taipei City,	Taiwan, R.O.C.	
Hereby sells, assigns and transfers to				
ASSIGNEE(S):				
N	Name:	Realtek Semiconductor Corp.		
A	Address:	2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.		
and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:				
"METHOD AND APPARATUS FOR IMAGE EDGE DETECTION"				
Which is found in:				
(a)	(a) U.S. patent application executed on even date			
(b) _	(b) U.S. patent application executed on			
(c) _	-	U.S. application serial no		
(d) _	I	patent no issued		

ASSIGNOR(S) (Inventors):

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this DEC 24 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)	Signature of INVENTOR
Chi-Feng Wang	Chi-Feng Wang
Chun-Hsing Hsieh	Chun Hsing Hsieh
Chia-Wei Yu	Chia Wer Yu